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Fabrication of 1D Te/2D ReS₂ Mixed-Dimensional van der Waals *p-n* Heterojunction for High-Performance Phototransistor

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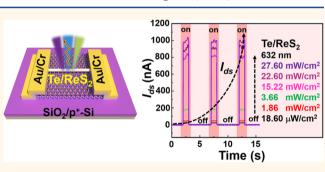
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ABSTRACT: The superior optical and electronic properties of the two-dimensional (2D) rhenium disulfide (ReS₂) makes it suitable for nanoelectronic and optoelectronic applications. However, the internal defects coupled with with the low mobility and light-absorbing capability of ReS₂ impede its utilization in high-performance photodetectors. Fabrication of mixed-dimensional heterojunctions is an alternative method for designing high-performance hybrid photodetectors. This study proposes a mixed-dimensional van der Waals (vdW) heterojunction photodetector, containing high-performance onedimensional (1D) p-type tellurium (Te) and 2D n-type ReS₂,



developed by depositing Te nanowires on ReS₂ nanoflake using the dry transfer method. It can improve the injection and separation efficiency of photoexcited electron-hole pairs due to the type II p-n heterojunction formed at the ReS₂ and Te interface. The proposed heterojunction device is sensitive to visible-light sensitivity (632 nm) with an ultrafast photoresponse (5 ms), high responsivity (180 A/W), and specific detectivity (10⁹), which is superior to the pristine Te and ReS₂ photodetectors. As compared to the ReS₂ device, the responsivity and response speed is better by an order of magnitude. These results demonstrate the fabrication and application potential of Te/ReS₂ mixed-dimensional heterojunction for high-performance optoelectronic devices and sensors.

KEYWORDS: photodetector, visible light, photoresponsivity, ReS₂ nanoflake, Te nanowires, van der Waals heterojunction

INTRODUCTION

The structures and optoelectronic properties¹⁻⁴ of the atomically thin-layered two-dimensional transition metal dichalcogenides (2D TMDs) make it suitable for photo-detector application.⁵⁻⁸ For photoelectronic applications, rhenium disulfide (ReS₂) is the most investigated among the 2D TMDs materials. It has weak interlayer coupling, direct band gap independent of thickness, distorted 1T structure, and low symmetry that enables application in the fabrication of photodetectors and sensors.⁹⁻¹¹ For ReS₂ photodetectors, the highest photoresponsivity (*R*) and detectivity (*D*) of 16.14 A/W and 1.30×10^{10} Jones, respectively, were achieved in previous studies.¹²⁻¹⁵ However, the low mobility of ReS₂ hampers the successful integration of ReS₂-based optoelectronic devices.¹⁶ Many factors determine the mobility of ReS₂ devices, including the scattering of carriers, substrate phonons, interfacial charged impurities, electron–photon coupling,

absorbents on the surfaces, and absorption of oxygen and water molecules in the process of device construction.^{17,18} In addition, the reduction in the optical absorption of ReS₂ is due to the one-atomic-layer thickness, which makes such monolayer devices inactive in actual application.¹⁹ Thus, improving the performance of the ReS₂ has garnered a lot of attention. Mukherjee et al. presented a multilayer ReS₂/Si *n*–*p* heterojunction with improved photoresponsivity of 33.47 A/W and operation time of 80 μ s.²⁰ Lodha et al. designed WSe₂/ ReS₂-based type-II *p-n* heterojunction photodetector, sensitive

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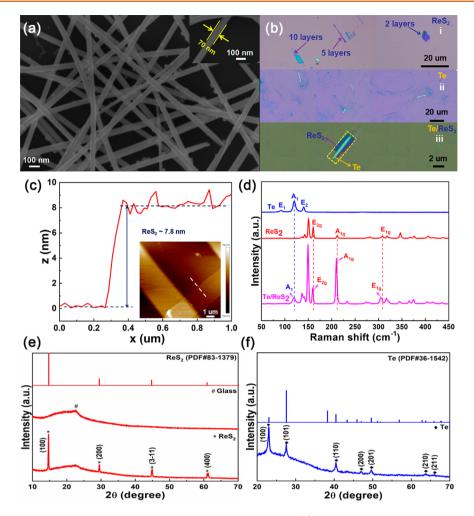


Figure 1. Characterizations of 1D Te/2D ReS₂ mixed-dimensional heterojunction. (a) SEM image of Te NWs. Inset: corresponding enlarged images of the single Te NW. (b) Optical microscope images of (i) 2D ReS₂ NFs with different thicknesses, (ii) single 1D Te NWs of different lengths, and (iii) typical 1D Te/2D ReS₂ mixed-dimensional heterojunction. (c) Typical cross-sectional height profile of the exfoliated ReS₂ NF from the AFM image along the white dashed line shown in the inset. (d) Raman spectra of the pristine Te NWs, ReS₂ NFs, and 1D Te/2D ReS₂ mixed-dimensional heterojunction. XRD patterns of (e) the obtained ReS₂ NFs and (f) Te NWs.

to IR light with the ultrafast response time of 5 μ s and high responsivity of 3 A/W.²¹ Lee et al. reported a Black Phosphorus (BP)/ReS₂-based type-III *p*-*n* heterojunction diode with photoresponsivity of 8 mA/W and external peak quantum efficiency of 0.3%.²² Lee et al. combined graphene with ReS₂ to fabricate a strong light absorption photodetector with outstanding detectivity of 10¹³ Jones, photoresponsivity of 10⁵ A/W, and responsivity of less than 30 ms.²³

Thus far, only a few studies have focused on the ReS₂ based mixed-dimensional hybrid van der Waals (vdW) heterojunction. Recently, Jariwala et al. proposed mixed-dimensional vdW heterojunctions for overcoming the limitation of electronics of 2D materials.²⁴ Many research studies have investigated such mixed-dimensional vdW heterojunctions for as an alternate platform for electronics and optoelectronics due to flexibility and high performance. Hu et al. achieved a broadband self-powered photodetector with sensitivity ranging from the UV to visible region by mixed-dimensional 1D Se– 2D InSe vdW heterojunction.²⁵ Ye et al. presented a high-performance dual-channel phototransistor based on a 1D Se/ 2D ReS₂ heterojunction developed using chemical vapor deposition.²⁶ Zhang et al. designed 0D–2D mixed vdW heterojunctions of perovskite quantum dots and MoS₂ monolayer for the high-performance phototransistor.²⁷ Seo et al. investigated the optoelectronic characterization of the $MoSe_2-WSe_2-MoSe_2$ mixed 2D-2D-2D device, which has a high photoresponsivity.²⁸ Such mixed-dimensional vdW heterojunctions offer exploration possibilities for highly responsive and special optoelectronic applications.

Tellurium (Te) is a *p*-type semiconductor, a promising material, with high mobility,²⁹ photoconductivity,³⁰ piezoelectricity,³¹ and thermoelectricity.³² Though, the singleatomic chain or the few-atomic chains in the Te crystal interacts due to the weak vdW of anisotropic atomic structure.³³ This one-dimensional (1D) vdW crystal structure along with physical properties and stability allows Te application in electronics, optoelectronics, and energy devices. For instance, Zhou et al. demonstrated that Te with high mobility and a deleloped photodetector exhibits high gain and wider operational bandwidth.³⁴ Javey et al. also fabricated Te on the Au/Al₂O₃ substrate for high-performance short-wave infrared photodetector.³⁵ Zhai et al. assessed a hydrogenassisted strategy for preparing Te, and the phototransistor was developed with high-performance gate-dependent photoresponsivity.³⁶ Besides, the 1D Te metal–semiconductor is also promising for mixed-dimensional vdW heterojunctions, but

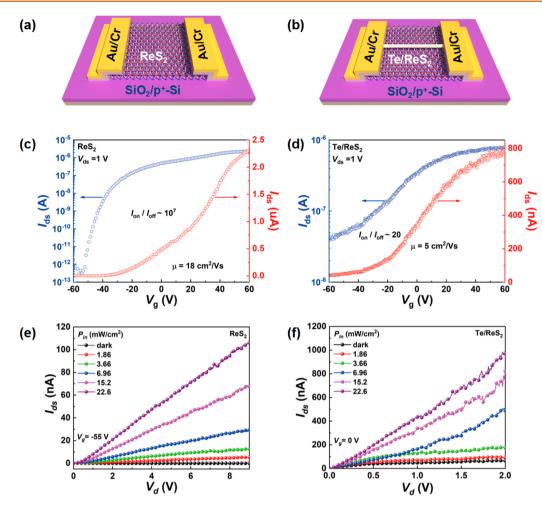


Figure 2. Schematic structure, transfer, and output characteristics of ReS₂ and Te/ReS₂ FETs under dark and light conditions. Schematic structure of (a) ReS₂ and (b) Te/ReS₂ phototransistors. (c,d) $I_{ds}-V_g$ curves of FETs at $V_d = 1$ V in the dark. (e,f) $I_{ds}-V_d$ curves with variable light power intensity (632 nm) at $V_g = -55$ V for ReS₂ and 0 V for Te/ReS₂ FETs. Figure S3a-c depict the $I_{ds}-V_d$ curves of FETs at V_g of 0 V to reveal the contact behaviors.

there is a lack of research on the photoelectric detection technology combining 2D materials with 1D Te nanowires (NWs). Further, the unclear interaction mechanism of 2D materials and 1D Te in the vdW heterojunctions hamper prospects in optoelectronic applications.

This study demonstrates a mixed-dimensional vdW heterojunction of 1D p-type Te NW and 2D n-type ReS2 nanoflake (NF) for photoelectric detection applications. The Te NWs were first prepared by a facile hydrothermal method and then transferred to the ReS₂ NFs layer using the dry transfer method. Subsequently, this study evaluated, in the context to the photodetector performance, the electrical properties of the proposed dual-channel field-effect transistors (FETs). Compared to 2D ReS₂ NF, the 1D Te/2D ReS₂ heterojunction shows a significant improvement in light absorption, an increase in the electron-hole pair concentration, and the improved injection and separation efficiency of electron-hole pairs at the interface. This significant improvement is due to the light trapping effect, type II band alignment, and built-in electric field in the constructed Te/ReS2 heterojunction. The photoresponsivity and photoresponse rate of the Te/ReS₂ heterojunction photodetector are superior to the bare Te or ReS₂ devices. Therefore, the 1D Te/2D ReS₂ heterojunction is a valuable addition to the array of mixeddimensional p-n heterojunction, which has widened the scope of the implementation in optoelectronics and sensor applications.

RESULTS AND DISCUSSION

Material Characterization. Figure 1a depicts the SEM image of the synthesized Te sample. The Te NWs with a length of more than 10 μ m appear uniformly on the silicon substrate. Besides, as depicted in the set of Figure 1a, the diameter of Te NW is about 70 nm. The calculated aspect ratio of Te is 200, which indicates the anisotropy of Te NWs, and the smooth surface of Te NWs indicates high purity and quality. Figure 1b demonstrates the optical images of ReS₂ NFs, the as-grown Te NWs, and Te/ReS₂ heterojunction. Part (i) depicts the different thicknesses of ReS₂ NFs distinguishable by the optical contrast. Part (ii) depicts the easy separation of single Te NW and multiple NWs, which are the conditions for successful transfer and device fabrication. A single nanowire with a thicker diameter is formed by clustering multiple single nanowires. Part (iii) depicts the single Te NW with a thicker diameter that is tightly attached to ReS₂ NF, forming a Te/ReS₂ heterojunction. Figure 1c and its insets show the measured corresponding thickness and AFM image of ReS₂, respectively. The thickness of ReS₂ NFs for the

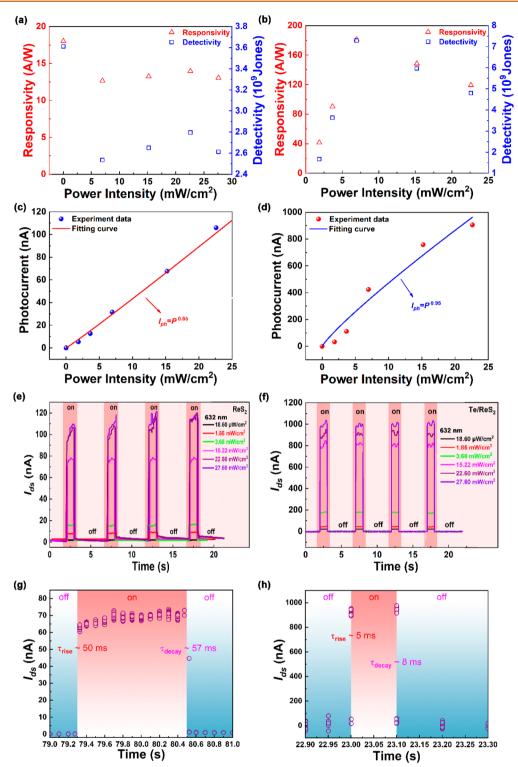


Figure 3. Optoelectronic performance characterization of the ReS₂ and Te/ReS₂ photodetectors. (a, b) Responsivity and detectivity and (c, d) experimental and fitted photocurrent of devices as a function of the illumination intensity. (e, f) Time-dependent photocurrent response under switched-on/off light irradiation with different power intensities at V_d of 9 and 2 V and V_g of -55 and 0 V for ReS₂ and Te/ReS₂, respectively. (g, h) Temporal illumination response of the single on/off cycle highlights τ_{rise} and τ_{decay} time under an illumination intensity of 15.22 mW/cm².

fabrication of devices is estimated to be 7.80 nm, which is appropriate as per the previously reported best optoelectronic performance.³⁷ Besides, no air bubbles in the overlapping heterojunction region indicate a strongly coupled Te and ReS_2 interface.

Figure 1d depicts the Raman spectra of Te, ReS_2 , and Te/ ReS₂ heterojunction. Specifically, for pristine Te (blue color spectrum), the three peaks at 92, 120, and 140 cm⁻¹ are the respective characteristic peaks of the E₁, A₁, and E₂ modes, as per the previous results.³⁸ For pristine ReS₂ (red color spectrum), the three Raman peaks at 160, 308, and 211 cm⁻¹ correspond to the E_g modes (in-plane vibration) and A_{1g} mode (out of plane vibration), respectively. These peak positions are as per the reported Raman results of ReS₂.³⁹ All the peaks of Te and ReS₂ presented in the constructed Te/ReS₂ interface indicate the formation of a Te/ReS₂ heterojunction. However, compared to the Raman peaks in pristine ReS2, minor blue shifts are observed in the Raman peaks in Te/ReS₂ due to the vdW interaction between top Te NW and bottom ReS₂ NF.⁴⁰ No apparent peak-shifts in the Raman peak positions of Te unveil the high-quality monolayer Te after fabrication of the vdW heterojunction. Diffraction peaks in Figure 1e validate the presence of triclinic phase ReS₂ (PDF no. 89-1379).⁴¹ Figure If shows the XRD patterns of Te NWs, with the diffraction peaks as per the hexagonal Te (PDF no. 36-1542).⁴² Besides, a lack of other impurity peaks establishes the superior crystallinity and purity of the as-grown Te NWs and ReS₂ NFs.

Figure S1 schematically illustrates the fabrication process of the Te/ReS₂ heterojunction photodetector. In addition, the experimental methods of the Supporting Information detail the process. First, the use of the two-step dry transfer provides the integrated Te/ReS₂ heterojunction. This method also establishes an intimate bonding between Te NW and ReS₂ NF. The vertical device structures obtained have four levels, ReS₂-on-SiO₂/p⁺-Si substrate, Te NF, and top Au/Cr electrodes. Subsequently, for the systematic comparison, the individual Te and ReS₂ PDs are also fabricated. Figure S2 depicts the SEM and optical microscope images of all devices.

Figure S3 depicts the I_{ds} - V_d curves at V_g of 0 V investigating the contact behaviors of FETs. The contacts at source/drain demonstrate Schottky behaviors of the Te NWs device at room temperature, while the ReS2- and Te/ReS2-based FETs demonstrate typical Ohmic behaviors. Parts a and b of Figure 2 depict the schematic structures of the devices. Parts c and d of Figure 2 show the transfer characteristics $(I_{ds}-V_g)$ on linear and semilogarithmic scales of ReS₂ and Te/ReS₂ FETs at the $V_{\rm ds}$ = 1 V in the dark. As depicted in Figure 2c, the ReS₂-based FET showed excellent *n*-type behaviors with a high on/off ratio $(\sim 10^7)$ and a low off-state current (10^{-13} A) . The observed threshold voltage ($V_{\rm th}$) of nearly -30 V suggests large electron concentration or natural n-doping for ReS2 device, which results from S vacancies or impurities of ReS₂ NFs.⁴³ Conversely, as depicted in Figure 2d, the Te/ReS₂ FETs show a poor on/off ratio (~ 20) and high off-state current (10⁻⁸ A). As compared to the ReS₂ FETs, $V_{\rm th}$ for Te/ReS₂ FETs shows a red shift from -30 to -20 V. At $V_{\rm g} = 60$ V and $V_{\rm ds}$ = 1 V, compared to ReS₂ FETs, the on-state current of Te/ ReS₂ FETs presents an order of magnitude decrease, which could significantly reduce the testing noise and enhance the detectivity of photodetectors. Such electrical behavior changes indicate that the hole carriers of *p*-type of Te flakes dominate the transport properties of Te/ReS_2 FETs, which attributes to the distinct *p*-doping effect of vertical stacked 1D Te NWs on the underlying 2D ReS₂ NFs. In addition, the transfer characteristic of Te was demonstrated in Figure S4 and a conspicuous *p*-type behavior was observed, which shows poor performance with low on/off ratio of about 10. The following relation provided the field-effect carrier mobility (μ):

$$\mu = \frac{L}{W} \left(\frac{\mathrm{d}I_{\mathrm{ds}}}{\mathrm{d}V_{\mathrm{g}}} \right) \frac{1}{C_{\mathrm{g}}V_{\mathrm{ds}}} \tag{1}$$

Among them, *L*, *W*, (dI_{ds}/dV_g) , and *C*_g are the channel length, channel width, slope of the transfer characteristics, and gate capacitance of the Si/SiO₂ substrate, respectively. Mobility for ReS₂ and Te/ReS₂ FETs was 18 and 5 cm²/(V s), respectively. The mobility of Te/ReS₂ FETs was much lower than that of ReS₂ FETs, similar to the previously reported values for other ReS₂-based FETs.²⁶

The laser diodes, as the light source, operating at a wavelength of 632 nm with different optical power densities (P_{in}) , investigated the optoelectronic properties of Te, ReS₂, and Te/ReS₂ FETs. Figure S5 presents the $V_{\rm g}$ - $I_{\rm ds}$ characteristics of ReS_2 and Te/ReS_2 devices at different light intensities. It shows that maximum change values in I_{ds} before and after illumination occur at a $V_{\rm g}$ of -55 and 0 V for ReS₂ and Te/ ReS₂ FETs, respectively. Figure S6 depicts optoelectronic properties of the Te NWs device, exhibiting a nonobvious response under 22.6 mW·cm⁻² illumination. Subsequently, parts e and f of Figure 2 show the $I_{ds}-V_d$ curves of ReS₂ and Te/ReS_2 devices under different optical power densities (P_{in}) of illumination and dark, respectively. It revealed that the dark current (I_{dark}) did not change much with increasing V_{ds} under no light illumination for all devices. At $V_{ds} = 9$ V, the I_{dark} was only 0.26 pA for ReS₂ FETs and 65.02 nA for Te/ReS₂ at V_{ds} = 0 V. Thus, all devices depicted a distinct photoresponse, where $I_{\rm ds}$ gradually increases with an increase in $P_{\rm in}$ from 1.86 to 22.6 mW/cm^2 . As compared to the Te device, Te/ReS₂ device had higher I_{ds} even at low P_{in} (1.86 mW/cm²), indicating a highly sensitive photodetection for the visible range (632 nm).

For photodetectors, responsivity (R) and detectivity (D) are critical parameters represented by the following equations⁴⁴

$$R = \frac{I_{\rm photo} - I_{\rm dark}}{P_{\rm in}A}$$
(2)

where I_{photo} is the measured photocurrent, I_{dark} is the dark current, and P_{in} and A are the light illumination intensity and active area.

$$D = \frac{R}{\left(2qI_{\text{dark}}/A\right)^{1/2}}\tag{3}$$

Among them, q represents the elementary charge. Parts a and b of Figure 3 show the calculated *R* and *D* under various incident power densities for ReS₂ and Te/ReS₂ heterojunction photodetectors. The maximum R and D of the ReS₂ device are 20 A/W and 3.6 \times 10⁹ Jones, respectively, at $V_{\rm d}$ = 1 V, and $V_{g} = -55$ V with the power density of 18.60 μ W/cm², which is higher the other ReS₂ photodetectors.⁷ Further, at the $V_d = 1$ V and power density of 18.60 μ W/cm², R of the Te/ReS₂ heterojunction photodetector was 180 A/W, which was one order higher than that of ReS_2 photodetector. Besides, the *D* of the Te/ReS₂ photodetector is 7.2×10^9 Jones, which promoted by two times compared to ReS₂ photodetector. The *D* is influenced by the defects of ReS_2 from S vacancies in Te/ReS₂ heterojunction, which leads the high dark current. Nonetheless, the 10^9 Jones of D is comparable with other reported composite structures.^{45,46} For the device defects verification, the incident light intensity-dependent photocurrent curves are as per the following power law⁴⁷

$$I \propto P^{\theta} \tag{4}$$

where I is the photocurrent, P is the light intensity, and θ is the power exponent. As depicted in Figure 3c,d, the power exponent (θ) is 0.85 and 0.95 for ReS₂ and Te/ReS₂

Table 1. Performance Parameters (Comparison of Photodetectors bas	sed on 1D Te NWs and 2D	ReS ₂ NFs with Other Mixed-
Dimensional Heterojunction Photo	detectors Reported in the Literat	ture	

photodetector	wavelength (nm)	responsivity (A/W)	detectivity (Jones)	rise time (s)	decay time (s)	refs
2D ReS ₂ nanoflakes	220	13		6	21	11
1D ReS ₂ nanowires	500	5.08×10^{5}	6.1×10^{15}	1.8	3.9	14
2D Te nanosheets	261	6.5×10^{4}	3.73×10^{8}	2	5	52
1D/2D Se/InSe	460	32	1.7×10^{11}	0.030	0.037	25
1D/2D t-Se/ReS ₂	400	98	6×10^{10}	0.05	0.05	26
1D/1D Te/TiO ₂	350	0.084	3.7×10^{9}	0.772	1.492	53
1D/2D Se/ReS ₂	370	36	8×10^{12}	0.01	0.01	45
1D/2D Sb ₂ Se ₃ /WS ₂	520	1.51	1.16×10^{10}	0.008	0.008	50
$2D/2D \ CdS/MoS_2$	610	3.91		0.01	0.01	54
1D/1D ZnO/Co ₃ O ₄	solar light	21.80	4.12×10^{12}	6	6	55
2D ReS ₂ nanoflakes	632	20	3.6×10^{11}	0.05	0.057	this work
$1D/2D \text{ Te/ReS}_2$	632	180	5×10^{9}	0.005	0.008	this work

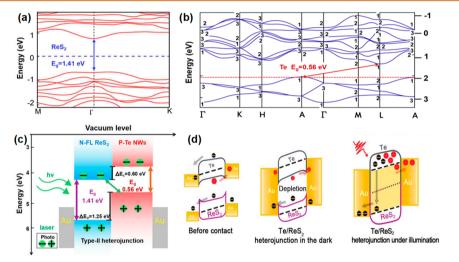


Figure 4. Electronic band structures of (a) ReS₂, and (b) Te. (c) Band alignment of the Te/ReS₂ heterojunction. (d) Energy band diagram and carrier transport of the Te and ReS₂ for before contact, after contact, and under light irradiation. The Fermi energy is set as zero energy.

heterojunction, respectively. For the ReS₂ photodetector, the sublinear response curve with light intensity indicates that the photogenerated carrier recombination due to intrinsic defects or the charge impurities at the surface of the ReS₂.⁴⁸ Moreover, the calculated θ of Te/ReS₂ is higher than ReS₂, which suggests the fewer recombination centers exist in the heterojunction. These results are dependent on the charge impurities around the ReS₂ with reduced after Te covering compared to intrinsic ReS₂. Besides, the part of the surface of ReS₂, previously occupied by O₂/H₂O, was drastically covered by the Te/ReS₂ interfaces due to surface recombination sites.⁴⁹ A similar sublinear dependence in Se/InSe and Sb₂Se₃/WS₂ vertical bilayer heterostructures have been previously reported.^{25,50}

The response speed includes the on/off current ratio, and the rise and decay time is another vital parameter for photodetector. This study further assessed the time dependence of photocurrent with the laser turning on or off for demonstrating the device response speed. As depicted in Figure 3e,f, upon illumination, the device current generated increases sharply, then stabilizes in a higher current, and finally vanishes in the dark, which is steady and reproducible over the repeated cycles, exhibiting excellent stability and reliability of all devices. Moreover, the photoswitching on/off ratio of Te/ ReS₂ (1000) is significantly higher than that the ReS₂ device (200), which is similar to the V_d – I_{ds} results demonstrated in

Figure 2e,f. The time taken by the pulse amplitude to rise from 10% to 90% of the maximum value and vice versa is the rise and decay time of devices. Further, the on/off current ratio and the rise and decay times of device were characterized and depicted in Figure 3g,h. For ReS₂, the rise and decay times were nearly 50 and 57 ms, respectively. The rise and decay times for the Te/ReS₂ device under illumination was equal or less than 5 and 8 ms, which was beyond the measurement capability of the equipment used. Compared to the bare ReS₂ photodetector, seven to ten times faster rising and decaying time was exhibited by the Te/ReS₂ heterojunction photodetector. This excellent performance can be due to the Te NWs acting as the absorption layer and the built-in electric field inducement, aiding in efficient photocarrier extraction from the Te/ReS₂ heterojunction.⁵¹ Optoelectronic performance parameters comparison of Te/ReS₂ photodetector with other mixed-dimensional visible heterojunction photodetectors reported in the literature demonstrated similarity and improvement (Table 1). It suggests a promising application of the proposed Te/ReS₂ for highly efficient visible photodetection.

The electronic band structures of ReS_2 and Te calculated by density functional theory are shown in Figure 4a,b. The calculation details are provided in Supporting Information. From the calculated results, the ReS_2 has a direct band gap of 1.41 eV, corresponding to the other reported result.⁵⁶ For Te, the results display the band gap of 0.56 eV, which is in accord

with the reported value.⁵⁷ As shown in Figure 4c, both the conduction band maximum (CBM) and valence band minimum (VBM) of Te are higher than that of ReS₂. Thus, the Te/ReS₂ heterojunction have a type II band alignment. Figure 4d demonstrates the photocarriers transmission of Te/ ReS₂ heterojunction under dark and light. Under dark conditions, Au, ReS2, and Te have different Fermi energies formation before contact with each other. The contact of ReS₂ and Te with Au forms the low Schottky barriers at the interfaces. The charge transfer and electron-hole recombination occurred at the Te/ReS2 interface during the Te/ReS2 heterojunction formation. This behavior of charge transmission lowers/raises the Fermi level of ReS₂ (Te), causing the formation of depletion regions and introducing a built-in field toward ReS₂. The depletion region formation accompanied by the Schottky barrier reduction at the Au/ReS₂ (Au/Te) interfaces significantly suppresses the dark current in the heterojunction bilayers.⁵⁸ The light illumination causes the generation of electron-hole pairs in the Te NWs; thereby the electrons are transferred to ReS2 NFs, and photoexcited holes in ReS₂ NFs transfer to Te NWs. The charge separation is beneficial in reducing electrons and holes recombination, which enhancing the photogenerated current. This phenomenon raises the Fermi level in ReS2 NFs while lowers that of Te NWs. The accumulated electrons (holes) in ReS₂ NFs (Te NWs) could transport through the two channels driven applied electric field of V_{ds} and be captured immediately by the electrodes, resulting in a high photocurrent.

Meanwhile, the reduced Schottky barriers at the contact interfaces (Au/ReS₂ and Au/Te) account by modulation of Fermi level also facilitate the carrier injection and enhances the channel current.⁵⁹ The ReS₂ can bond with gas molecules for the high chemical activity of Re atom. As a result, the trap states in the band gap generate that will a poor photoresponse speed.⁶⁰ The introduction of Te NWs enhances the absorption of light and causes surface defects of ReS₂, which significantly increases the photocurrent. Furthermore, the Re–Te bond at the interface provides a direct path for carrier separation and transfer, which accelerated the response speed.⁶¹

CONCLUSIONS

In summary, this study proposes a fabricated 1D Te/2D ReS₂ mixed-dimensional van der Waals p-n heterojunction using hydrothermal, mechanical exfoliation, and dry transfer methods. This study had explored the electronic and optoelectronic properties of Te NWs, ReS2 NFs, and their heterojunction devices. Compared to the pristine Te and ReS₂ photodetectors, the Te/ReS₂ heterojunction photodetector has superior performance with excellent responsivity (180 A/W), high specific detectivity (10^9) , and short photoresponse time (5 ms). The responsivity and response time are higher by 1 order of magnitude than the ReS2-alone device. These improvements are due to the benefits from the type-II band alignments, enhanced light absorption, and passivate surface effect of heterojunction, which also rapidly separates the photogenerated electron-hole pairs. The performance improvements reported in this study can provide a fabrication method of mixed-dimensional van der Waals heterojunction for optoelectronic applications.

EXPERIMENTAL SECTION

Growth of 1D Te NWs. To construct 1D Te/2D ReS_2 mixeddimensional heterojunction, first the Te NWs were synthesized by the hydrothermal method as previously reported.⁵³ This process provides Te NWs of controlled diameters and lengths. All the chemicals in the experiment were weighed using a METTLER TOLEDO ME 204 balance. Furthermore, Te NWs synthesized by the hydrothermal method have demonstrated excellent optical and electrical properties, which show potential for photodetector application.^{62,35}

Fabrication of the Heterojunction Photodetectors. First is the alcohol dispersion of the as-prepared Te NWs, and next is the coating on a SiO₂ (280 nm)/p⁺-Si wafer by a spin-coating method for transfer process. Simultaneous is the mechanical exfoliation of ReS₂ NFs from a ReS₂ bulk (Six Carbon Technology Supplies) onto the SiO₂ (280 nm)/p⁺-Si substrate with a scotch-tape method. The ReS₂ NFs of 7–8 nm thickness on the proper lateral size of the substrate was selected for the heterojunction fabrication. Later, Te NWs transferred onto the ReS₂/Si substrate by a dry transfer method with the help of accurate transfer platform (Metatest, E1-T), froms the 1D Te/2D ReS₂ mixed-dimensional heterojunction. For the fabrication of Te, ReS₂, and Te/ReS₂ devices, source-drain electrodes were defined by the electron beam lithography and followed by the deposition of Cr/Au with 10/70 nm deposited by physical vapor deposition equipment, followed by a lift-off process in acetone.

Characterizations and Measurements of Photodetectors. An X-ray diffractometer (Bruker, D8) was used to determine the crystalline structure of samples. Raman spectroscopy (Lab RAM HR800, Horiba Jobin Yvon) with an excitation wavelength of 532 nm analyzed the optical properties. The thickness and surface morphology of samples were measured by AFM (Dimension Icon, Bruker) in tapping mode and SEM (Sigma HD, Zeiss), respectively. The electrical performance measurement was by a semiconductor parameter analyzer (Keysight, B1500) in a robe station (Lake Shore). For photodetector performance measurements, a light source of 632 nm laser diode (Thorlabs, LD632P70MLD) evaluated the photoresponse. The laser first passes through the collimator to obtain a parallel beam, which then shines onto the device channel. The laser switch controlling is by the laser controller (Thorlabs, LDC4001), which can achieve photoresponse speed measurement. The signal was amplified through a lock-in amplifier (Stanford, SR570) and then detected by a digital oscilloscope.

ASSOCIATED CONTENT

Supporting Information

The Supporting Information is available free of charge at https://pubs.acs.org/doi/10.1021/acsnano.0c09912.

Experimental methods, schematic for the fabrication process of Te, ReS₂, and Te/ReS₂ FET based phototransistors, SEM and optical microscope images of ReS₂ and Te/ReS₂ devices, $I_{ds}-V_d$ curves at V_g of 0 V of Te, ReS₂, and Te/ReS₂ devices, transfer curve of Te FET measured under dark at $V_{ds} = 1$ V, V_g-I_{ds} characteristics of ReS₂ and Te/ReS₂ devices at different light intensity with the wavelength of 632 nm, and I_d-V_d of pure Te device under dark conditions and at maximum light intensity of 22.6 mW/cm² with the wavelength of 632 nm (PDF)

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Author Contributions

J.T., J.J., and Y.Z. designed the research. S.Z. and X.L. performed the XRD and Raman measurements. X.F. and P.W. contributed to device fabrication. W.H., Y.L., L.L., and D.Z. assisted with data analysis. J.T. wrote the paper, and all authors commented on the manuscript.

Notes

The authors declare no competing financial interest.

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